



Conflict Minerals Statement for Printed Circuit Boards – EU Compliance

I. Statement Purpose

The Company hereby solemnly declares its policies, positions and practice commitments regarding conflict minerals in the Printed Circuit Boards (PCB) produced and sold, ensuring full compliance with the EU Conflict Minerals Regulation (EU 2017/821), OECD Due Diligence Guidance for Responsible Supply Chains of Minerals from Conflict-Affected and High-Risk Areas, and relevant international standards.

II. Mineral Usage Specification

1. Minerals Not Used

The Company does not intentionally add or use Cobalt (Co) or Natural Mica in the production process or finished PCB products, and there is no compliance risk related to the supply chain of these minerals.

2. Minerals Possibly Used

Depending on specific product specifications and functional requirements, some PCB products may contain Tin (Sn) or Gold (Au) (both falling under the 3TG minerals regulated by EU regulations), mainly used in key components such as solders and coatings, with usage strictly adhering to product design and customer technical requirements.

III. Core Commitments

1. Regulatory Compliance

Strictly adhere to EU conflict minerals regulations and international responsible sourcing initiatives, firmly opposing the use of any conflict minerals that directly or indirectly fund armed conflicts or human rights violations.

2. Supply Chain Control

Establish a comprehensive due diligence mechanism covering the entire supply chain. For 3TG minerals such as Tin and Gold, require upstream suppliers to obtain raw materials exclusively from conflict-free sources and implement supply chain risk management in accordance with the OECD Five-Step Due Diligence Framework.

3. Supplier Management

Mandate suppliers to provide mineral origin and smelter information via the Conflict Minerals Reporting Template (CMRT, current latest version 6.5), and give priority to smelters certified under the Responsible Minerals Initiative (RMI) Responsible Minerals Assurance Process (RMAP).



4. 4.Continuous Improvement

Regularly audit supplier compliance, track the progress of supply chain transparency enhancement, update conflict minerals control processes in a timely manner, and accept reasonable supervision and inquiries from customers and relevant parties.

IV. Disclaimer

Due to the complexity of the global supply chain, the Company has exercised reasonable efforts to conduct due diligence but cannot fully guarantee 100% conflict-free status of the entire supply chain at this stage. This statement reflects the Company's current policies and practices and does not constitute a legal warranty for future performance. The Company reserves the right to revise this statement in accordance with changes in regulations and industry standards.

V. Contact Information

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